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PATENT

Docket No.: NAUP0240USA

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

## RECORDING COVER SHEET

Assianor:

Kun-Lin Wu, J.J. Huang

2. Assignee: UNITED MICROELECTRONICS CORP.

No.3, Li-Hsin Road 2,

Science-Based Industrial Park,

Hsin-Chu, Taiwan, R.O.C.

3. Nature of Conveyance: Assignment of patent

4. Reference number: Application filed herewith.

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79/164329

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Number of applications affected by this recording: 1

Total fee:  $(1 \times 40) = 40.00$  Payment by check enclosed Authorization is hereby given to charge the over payment to deposit account #500801

- Execution date of the document to be recorded: 01/16/2001 7.
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Winston Hsu U.S. Patent Agent Reg. No.:41,526

REEL: 011480 FRAME: 0443

**PATENT** 

Docket No: NAUP0240USA

## ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNORS (Inventors):			
Name:	Kun-Lin Wu	Nationality: R.O.C.	
Address:	No.20, Lane 15, King-Fu St., Chu-Tung Town, Hsin-Chu Hsien, Taiwan, R.O.C.		
Name:	J.J. Huang	Nationality: R.O.C.	
Address:		Kuang-Fu Rd., Hsin-Chu City, Taiwan, R.O.C.	
Hereby sells, assigns and transfers to <a href="UNITED MICROELECTRONICS CORP.">UNITED MICROELECTRONICS CORP.</a> (hereinafter 'Assignee'), of (Assignee address)  No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C. , and the successors assigns and legal representatives of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:  "Method of preventing dishing phenomenon atop a dual damascene structure"			
Which is foun	d in:		
	U.S. patent application executed on even date		
	U.S. patent application executed on		
(c)	U.S. application serial no		
(d)	patent no.	issued	
		ined for said invention by the above application or an	

and, in and to, all Letters Patent to be obtained for said invention by the above application or ant continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or reexamination thereof

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Combined Declaration and Power of Attorney, Page

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ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this  $\frac{\sqrt{|0|} \times |0|}{\sqrt{|0|}}$  (Date of signing).

(Type name of inventor)	Signature of INVENTOR
Kun-Lin Wu	Kun-Lin Wn /10/2001
J.J. Huang	J. J. Huang 1/8/2001

Combined Declaration and Power of Attorney, Page

**RECORDED: 01/19/2001** 

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